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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Keun-hyuk Lee	12/20/2007
Seung-won Lim	12/20/2007
Sung-min Park	12/20/2007
Taek-keun Lee	12/20/2007

RECEIVING PARTY DATA

Name:	Fairchild Korea Semiconductor, Ltd.	
Street Address:	82-3, Dodang-dong, Womni-gu	
Internal Address:	Gyeonggi-do	
City:	Bucheon Si	
State/Country:	KOREA, DEMOCRATIC PEOPLE'S REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11969410

CORRESPONDENCE DATA

Fax Number: (585)325-5458

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 585-325-7570

Email: tfitzgerald@hiscockbarclay.com
Correspondent Name: HISCOCK & BARCLAY, LLP

Address Line 1: 2000 HSBC PLAZA
Address Line 2: 100 Chestnut Street

Address Line 4: ROCHESTER, NEW YORK 14604-2404

ATTORNEY DOCKET NUMBER: 3023016 (FS-29483-US)

NAME OF SUBMITTER: Thomas R. FitzGerald

Total Attachments: 2

PATENT REEL: 020319 FRAME: 0161

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PATENT REEL: 020319 FRAME: 0162

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FAIRCHILD SEMICONDUCTOR CORPORATION

Assignment

As a below named inventor or joint inventor of an invention or improvement entitled:

HIGH POWER SEMICONDUCTOR PACKAGE Attorney Docket No. 3023016 (FS-29483-US)

for which I have executed an application for Letters Patent of the United States of America, on an even date herewith; and

WHEREAS, FARCHILD KOREA SEMICONDUCTOR, LTD., a Large Entity, organized and existing under the laws of the Republic of Korea, having a principal place of business at (420-711) 82-3 Dodang-Dong, Wonmi-gu, Bucheon-si, Gyeonggi-du, Korea, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged. I have sold, assigned, transferred, and set over, and by these presents do hereby sell, assign, transfer and set over, unto said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, my entire right, title and interest in, to, and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuation applications thereof, and all Letters Parent of the United States of America which may be granted thereof and all reissues and extensions hereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention, all rights to register said invention in appropriate registries, and all Letters Patent which may be granted for said invention in any country or countries foreign to the Unites States of America, and all extensions, renewals, and reissues thereof, and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, in accordance with the terms of this instrument.

And I hereby covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

And I hereby further covenant and agree that I will communicate to said FAIRCHILD KOREA SEMICONDUCTOR. LTD., its successors, legal representatives, and assigns, any fact known to me respecting said invention, and testify in any legal proceeding, sign all tawful papers, execute all divisions, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to ald said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

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Attorney Docket: 3023016 (FS-29483-US)

IN TESTIMONY WHEREOF, I authorize and affirm said assignments with the signature(s) set forth below on the indicated date(s).

Inventors:

Lee

Task-keun Lee

Date

Dec. 20.

Date

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RECORDED: 01/04/2008

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PATENT REEL: 020319 FRAME: 0164